RF Transformer

TC1-15

CASE STYLE: AT224

PRICE: Contact Sales Dept.

50Ω

350 to 1500 MHz

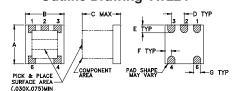
Maximum Ratings

Operating Temperature	-40°C to 85°C
Storage Temperature	-55°C to 100°C
RF Power	0.25W
DC Current	30mA
Darmonant damage may easy if any of t	these limits are avecaded

Pin Connections

PRIMARY DOT	6
PRIMARY	4
SECONDARY DOT	1
SECONDARY	3
NOT USED	2

Outline Drawing AT224



PCB Land Pattern



Suggested Layout, Tolerance to be within ±.002

Outline Dimensions (inch)

.150	.150	.150	.050	.030	.025
3.81 G	3.81 H	3.81 J	1.27 K	0.76	0.64 wt
.028	.065	.190	.030		grams
0.71	1.65	4.83	0.76		0.10

Config. G

PRI

Features

- wideband, 350 to 1500 MHz
- · balanced transmission line
- · leadless surface mount
- · good return loss
- · aqueous washable

Applications

- PCS
- cellular
- impedance matching
- balanced amplifier
- baluns

Transformer Electrical Specifications

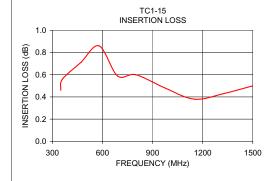
MODEL	Ω	FREQUENCY	II	S*	
NO.	RATIO	(MHz)	3 dB MHz	2 dB MHz	1 dB MHz
TC1-15	1	350-1500	_	350-1500	800-1500

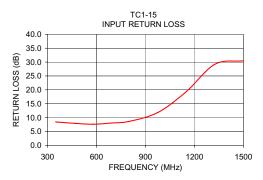
* Insertion Loss is referenced to mid-band loss, 0.35 dB typ.

NON-CATALOG

Typical Performance Data

FREQUENCY (MHz)	INSERTION LOSS (dB)	INPUT R. LOSS (dB)	
350.00	0.46	8.47	
360.00	0.56	8.38	
470.00	0.71	7.92	
580.00	0.86	7.58	
690.00	0.59	8.03	
800.00	0.60	8.62	
975.00	0.48	11.81	
1150.00	0.38	19.36	
1325.00	0.43	29.22	
1500.00	0.50	30.48	





Mini-Circuits

ISO 9001 ISO 14001 AS 9100 CERTIFIED

For detailed performance specs



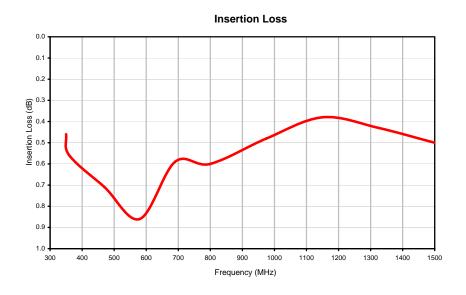
RF Transformer TC1-15

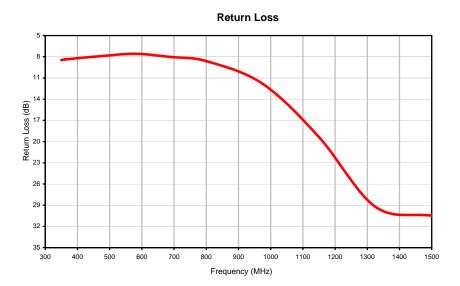
Typical Performance Data

FREQUENCY (MHz)	INSERTION LOSS (dB)	RETURN LOSS (dB)
350.00	0.46	8.47
360.00	0.56	8.38
470.00	0.71	7.92
580.00	0.86	7.58
690.00	0.59	8.03
800.00	0.60	8.62
975.00	0.48	11.81
1150.00	0.38	19.36
1325.00	0.43	29.22
1500.00	0.50	30.48

RF Transformer TC1-15

Typical Performance Curves

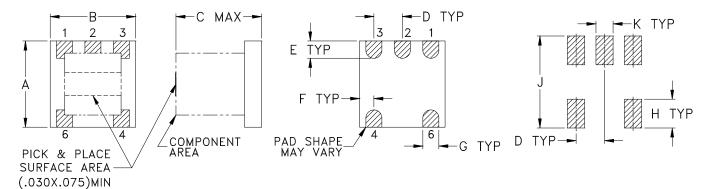




Outline Dimensions

AT224

PCB Land Pattern



Suggested Layout, Tolerance to be within $\pm .002$

CASE #	A	В	C	D	Е	F	G	Н	J	K	L	WT. GRAMS
AT224	.150 (3.81)	.150 (3.81)	.150 (3.81)	.050 (1.27)	.030 (0.76)	.025 (0.64)	.028 (0.71)	.065 (1.65)	.190 (4.83)	.030 (0.76)		.10

Dimensions are in inches (mm). Tolerances: 2 Pl. ± .01; 3 Pl. ± .005

Notes:

- Open style, ceramic base.
- Termination finish:

For RoHS Case Styles: 2-10 μ inch (.05-.25 microns) Gold over 100-300 μ inch (2.54-7.62 microns) Nickel plate. All models, (+) suffix.

For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.

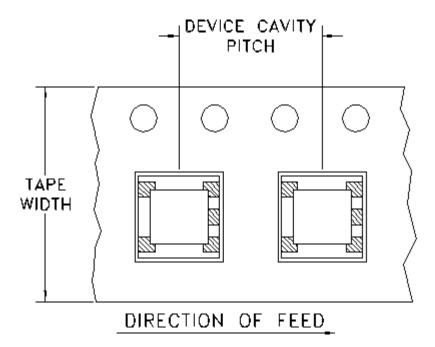




P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com

Tape & Reel Packaging TR-F17

DEVICE ORIENTATION IN T&R



Tape Width, mm			Devices	s per Reel
			Small	20
			quantity	50
		7	standards	100
12	8		(see note)	200
				500
		12	Ctondond	1000
		13	Standard	2000

Note: Please Consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf





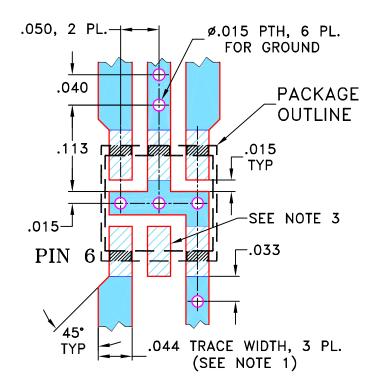
P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com

RF/IF MICROWAVE COMPONENTS

THIRD ANG	LE PROJECTION
(

		REVISIONS			
REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M106563	NEW RELEASE	08/23/06	AV	IG

SUGGESTED MOUNTING CONFIGURATION FOR AT224/DB714 CASE STYLE, "qs/ha/hd" PIN CONNECTIONS (FOR SINGLE ENDED TO BALANCED APPLICATION)



- NOTES: 1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .020" ± .0015"; COPPER: 1/2 OZ. ON EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
 - 2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.
 - 3. THIS PAD IS NOT REQUIRED FOR AT224 CASE STYLE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED		INITIALS	DATE		¬		• 4 ®	
DIMENSIONS ARE IN INCHES	DRAWN	AV	07/28/06		\perp Mini	i–Circu	1ts 13 Neptu	ne Avenue NY 11235
TOLERANCES ON: 2 PL DECIMALS ±	CHECKED	IL	08/23/06		Τ		Brooklyn	NI IIZJO
3 PL DECIMALS ± .005	APPROVED	IG	08/23/06]				
FRACTIONS ±				PL.	gs/ha/hd	, AT224/DB71	4. TC/TCM.	TB-145
□ Mini-	Mini-Circuits ®				6-77	,	_, _ , _ , _ , _ ,	
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	PARTY, IN WHOLE OR IN PART, WITHOUT WRITTEN PERMISSION OF MINI-CIRCUITS.					SCALE: 8.1	SHEET: 1	OF 1

ASHEETA1.DWG REV:A DATE:01/12/95

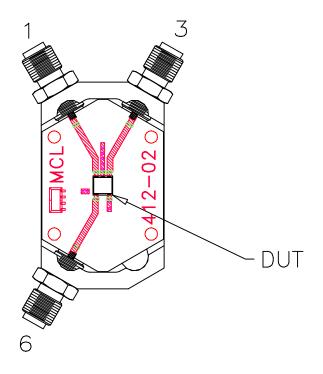
98PL244

8:1

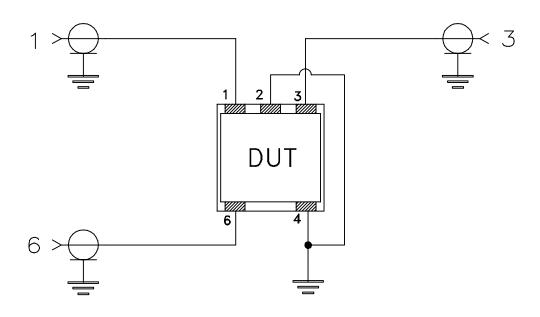
1 OF 1

Evaluation Board and Circuit

For Pin Connections refer to Data Sheet of the DUT



TB-145



Schematic Diagram

Notes:

- 1. 50 Ohm SMA Female connectors.
- 2. PCB Material: Rogers RO4350B or its equivalent, III Mini-Circuits® Dielectric Constant=3.5, Thickness=.020"



Environmental Specifications

ENV02T1

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215

ENV02T1 Rev: B

02/25/11

M130240 File: ENV02T1.pdf

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